

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

PHOTODIODE

MODEL No.

PD3122F

Specified for

Enclosed please find copies of the Specifications which consists of 11 pages including cover. After confirmation of the contents, please be sure to send back copies of the Specifications with approving signature on each.

CUSTOMER'S APPROVAL

DATE

BY

PRESENTED

DATE

Q. C BY

O. Ichikawa, Department General Manager of Engineering Dept., Ⅲ Opto-Electronic Devices Div. ELECOM Group SHARP CORPORATION Product name : PHOTODIODE

Model No.: PD3122F

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- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas ;
 - OA equipment Audio visual equipment Home appliances
 - Telecommunication equipment (Terminal) Measuring equipment
 - Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals Gas leakage sensor breakers Rescue and security equipment • Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

Space equipment
Telecommunication equipment (for trunk lines)
Nuclear power control equipment
Medical equipment

- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.

SPEC. No. ED-01042

FERENCE

1. Application

This specification applies to the outline and characteristics of position sensitive detector photodiode Model No. PD3122F.

February 26, 2001

ENCF

PAGE

2/10

ED-01042

No.

2. Outline

Outline drawing No. : CY7444G02

Mark specification drawing No. : CY7445G06

3. Ratings and characteristics

Refer to the attached sheet, page 6, 7.

4. Reliability

Refer to the attached sheet, page 8.

5. Outgoing inspection

Refer to the attached sheet, page 9.

- 6. Supplement
 - 6-1 Packaging specifications

Refer to the attached drawing No. CY10247G09.

- 6-2 Appearance : Such appearance changes as discoloring, rust, smear or blur shall be accepted, which doesn't affect electro-optical characteristics.
- 6-2 This product is not designed against electromagnetic and ionized-particle irradiation.
- 6-3 This product shall not contain the following materials. Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_S, Halon, Carbon tetrachloride 1.1.1-Trichloroethane (Methylchloroform)

6-4 Product mass (Piece) : Approximately 60mg

7. Notes

(7-1) Cleaning conditions :

Solvent cleaning : Solvent temperature 45°C or less Immersion for 3 min or less

Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.

February 26, 2001

ENCE

PAGE 3/10

ED-01042

The cleaning shall be carried out with solvent below.

Solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

(7-2) Soldering

The lead pins should be soldered according to the absolute maximum ratings. While or after soldering, the lead pins shall be free from physical stress. This device shall not be soldered with preheat or reflow.





- 3. Ratings and characteristics
 - 3.1 Absolute maximum ratings

Parameter	Symbol	Rating	Unit
Reverse voltage	V _R	30	v
Operating temperature	Topr	-25 to +85	S
Storage temperature	Tstg	-40 to +85	Ĵ
Soldering temperature *	Tsol	260	J

* MAX. for 3 seconds at soldering area



Solderable area

3.2 Electro-optical characteristics

Ta=25℃

February 26, 2001

RENCE

PAGE 6/10

01042

Ta=25℃

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Reverse voltage	V _R	I _R =10 μA	30	-	-	v
Dark current	Id	V _R =1V	-	-	2.0	nA
Output current	I _L *1	V_R =1V, Ev=1000 ℓ x	6.4	9.2	12	μA
Terminal capacitance	Ct	V _R =1V, f=10kHz	-	10	30	pF
Peak sensitivity	λp	V _R =0V	-	940	-	nm
Response time	tr, tf *2	$V_R = 1V, R_L = 1k\Omega$	-	5	35	μs
Resistance between electrode	Rie	V _R =1V, Va=0.5V	110	140	170	kΩ
Error of position detection	- *3	-	-	-	±25	μm
Sensitivity	R	-	-	0.5	-	A/W
Forward voltage	V _F	I _F =1mA	-	-	1.0	v

*1 $I_L = I_1 + I_2$

However, I_1 and I_2 are output current of Anode A and Anode B

Ev: Illuminance by CIE standard light source A (tungsten lamp)

*2 Test circuit for response time is shown below.



February 26, 2001

RENCE

PAGE 7/10

ED-01042

*3 75% area from detecting portion center to the edge of detecting portion Definition of error of position detection ($\lambda = 830$ nm, $\phi 200 \,\mu$ m spot) Error of position detection of each incident light position defines the following formula if electrical center position is $I_1 = I_2$.

Error of position detection $(\mu m) = \frac{L}{2} \times \frac{I_1 - I_2}{I_1 + I_2}$ - incident light position (μm)

L: Length of light detector surface=1.2mm



(3-3) Spectral sensitivity (TYP.)

4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level : 90% LTPD : 10%/20%

February 26, 2001 PAGE 8/10

	•		
Test Items	Test Conditions	Failure Judgement Criteria	Samples (n) Defective(C)
Temperature cycling	l cycle -40℃↔→+85℃ (30min) (30min) 20 cycles test		n=22, C=0
High temp. and high humidity storage	+60°C,90%RH, 500h	Rie≧U×1.2 Rie≦L×0.8	n=22, C=0
High temp. storage	+85℃, 500h	$V_R \leq L \times 0.8$	n=22, C=0
Low temp. storage	-40°C, 500h	$Id \ge U \times 2.0$	n=22, C=0
Operation life	Ev=3000ℓx, Ta=25℃, 500h	$I_{\rm L} \leq L \times 0.8$	n=22, C=0
High temp. reverse bias	+85℃, V _R =10V, R _L =100kΩ 500h	$I_L \ge U \times 1.2$	n=22, C=0
Mechanical shock	1000m/s^2 , 6ms, Sine wave 3 times/±X, ±Y, ±Z direction		n=11, C=0
Variable frequency vibration	200m/s ² 100 to 2000 to 100Hz/4 min 48 min/X, Y, Z direction	U: Upper specification	n=11, C=0
Terminal strength (Tension)	Weight: 2.5N 10 s/each terminal	limit L: Lower	n=11, C=0
Terminal strength (Bending)	Weight: 1.25N $0^{\circ} \rightarrow 90^{\circ} \rightarrow 0^{\circ} \rightarrow -90^{\circ} \rightarrow 0^{\circ}$ The one test should be performed.	specification limit	n=11, C=0
Solvent resistivity	Immerse in Isopropyl alcohol and Ethyl alcohol for 1 minute each		n=11, C=0
Soldering heat	260℃, 3 s Soldering area : Refer to page 6		n=11, C=0
Solderability	230±5℃, 5±0.5 s Dipped area : Soldering area (Refer to page 6)	Solder shall be adhere at the area of 95% or more of dipped portion.	n=11, C=0

- 5. Outgoing inspection
 - (1) Inspection lot

Inspection shall be carried out per each delivery lot.

(2) Inspection method

A single sampling plan, normal inspection level || based on ISO2859 shall be adopted.

Parame	ter	r Inspection items and test method	
	1	Disconnection, short	
2		Inverse polarity on terminal	
Major defect	3	Soldering defect (Obstacle to use)	0.065
	4	Characteristics defect (I _L , Id) in parameter 3.2.	
Minor defect	1	Appearance * (Crack, Split, Chip, Scratch, Stain, Blur, Foreign matter, Bubble)	0.65

※ ∙ Crack

···Visible crack irrespective of its position shall be defect.

February 26, 2001 PAGE 9/10

Split, Chip,
Scratch,

One which affects the characteristics of

• Stain, Blur

- Bubble Foreign matter (One on resin surface which can wipe off shall not be applied.)
 - 1. On light detector : $\phi 0.2$ mm or more shall be defect.
 - 2. Area excepting on light detector : $\phi 0.4$ mm or more shall be defect.



February 26, 2001

ED-01042



(Fig.3)

Package method (Quantity per a packing case : 2000pcs.)

- (1) 50pcs. products shall be packaged in a sleeve and both of sleeve edges shall be fixed by stoppers. (Fig. 1)
- (2) MAX. 40 sleeves (5 lines in 8 rows) above shall be packaged in a packaging case. (Fig.2)
- (3) Model No., quantity and inspection date shall be marked on the label and this label shall be put on the side of the packaging case. Case shall be closed with the lid and enclosed with P.P. tape. (Fig.3)
- (4) Formal packeged mass : Approximately 400g